

General Description

The MY6N80P is silicon N-channel Enhanced VDMOSFETs, obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy.

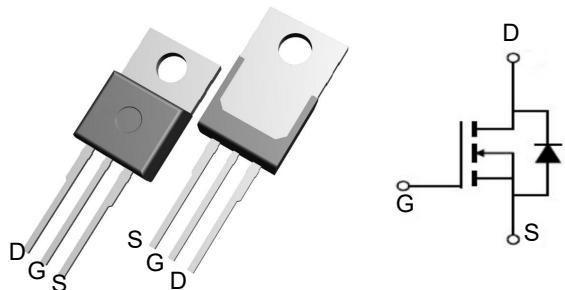


Features

V _{DSS}	800	V
I _D	6	A
P _D (T _C =25°C)	47	W
R _{DS(ON)} (at V _{GS} = 10V)	< 2.5	Ω

Application

- High efficiency switch mode power supplies
- Power factor correction
- Electronic lamp ballast



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MY6N80P	TO-220	MY6N80P	1000

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	800	V
I _D	Drain Current	T _j =25°C 6	A
		T _j =100°C 3.8	
V _{GS(TH)}	Gate Threshold Voltage	±30	V
E _{AS}	Single Pulse Avalanche Energy (note1)	590	mJ
I _{AR}	Avalanche Current (note2)	5	A
P _D	Power Dissipation (T _j =25°C)	47	W
T _j	Junction Temperature(Max)	150	°C
T _{stg}	Storage Temperature	-55~+150	°C
TL	Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	300	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJC}	Thermal Resistance,Junction to Case	-	2.66	°C/W
R _{θJA}	Thermal Resistance,Junction to Ambient	-	62.5	°C/W

Electrical Characteristics (T_c=25 °C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0	800	-	-	V
△BV _{DSS} /△T _J	Breakdown Voltage Temperature Coefficient	I _D =250μA, Reference to 25°C	-	0.9	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =800V, V _{GS} =0V	-	-	10	μA
		V _{DS} =640V, T _J =125°C			100	
I _{GSSF}	Gate-body leakage Current, Forward	V _{GS} =+30V, V _{DS} =0V	-	-	100	nA
I _{GSSR}	Gate-body leakage Current, Reverse	V _{GS} =-30V, V _{DS} =0V	-	-	-100	
On Characteristics						
V _{GS(TH)}	Date Threshold Voltage	I _D =250μA, V _{DS} =V _{GS}	3	-	5	V
R _{DS(ON)}	Static Drain Source On-Resistance	I _D =3A, V _{GS} =10V	-	-	2.5	Ω
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0, f=1.0MHz	-	1230	-	pF
C _{oss}	Output Capacitance		-	95	-	
C _{rss}	Reverse Transfer Capacitance		-	11	-	
Switching Characteristics						
T _{d(on)}	Turn-On Delay Time	V _{DD} =400V, I _D =6A R _G =25Ω (Note 3,4)	-	22	55	nS
T _r	Turn-On Rise Time		-	60	130	
T _{d(off)}	Turn-Off Delay Time		-	55	120	
T _f	Turn-Off Rise Time		-	40	90	
Q _g	Total Gate Charge	V _{DS} =640V, V _{GS} =10V, I _D =6A (Note 3,4)	-	31	-	nC
Q _{gs}	Gate-Source Charge		-	5.6	-	
Q _{gd}	Gate-Drain Charge		-	12	-	
Drain-Source Diode Characteristics and Maximum Ratings						
I _s	Max. Diode Forward Current	-	-	-	6	A
I _{SM}	Max. Pulsed Forward Current	-	-	-	24	
V _{SD}	Diode Forward Voltage	I _D =6A	-	-	1.4	V
T _{rr}	Reverse Recovery Time	I _s =6A, V _{GS} =0V diF/dt=100A/μs (Note 3)	610	-	-	nS
Q _{rr}	Reverse Recovery Charge		4.7	-	-	μC

Notes : 1, L=11.1mH, IAS=6A, VDD=50V, RG=25Ω, Starting TJ =25°C

2, Repetitive Rating : Pulse width limited by maximum junction temperature

3, Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

4, Essentially Independent of Operating Temperature

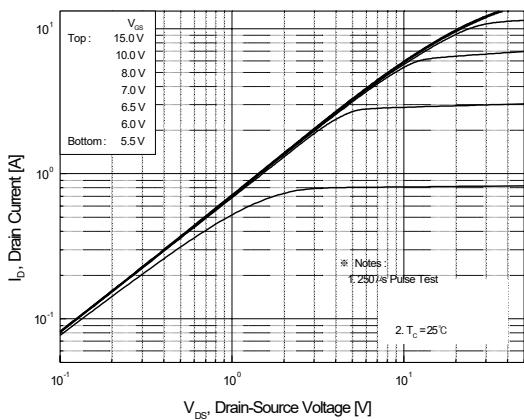


Figure 1. On-Region Characteristics

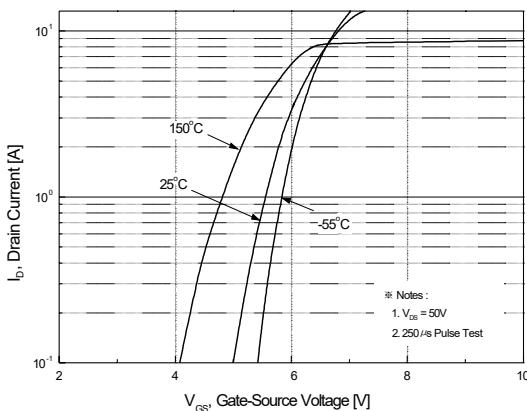
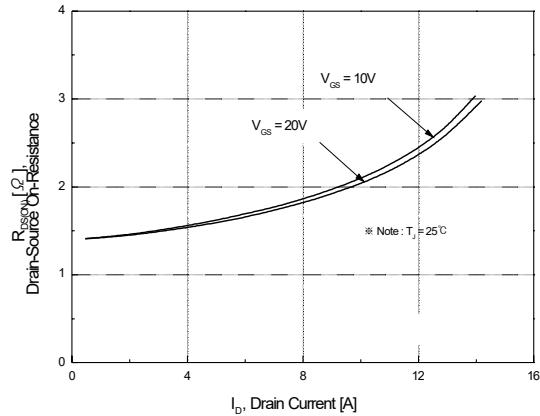
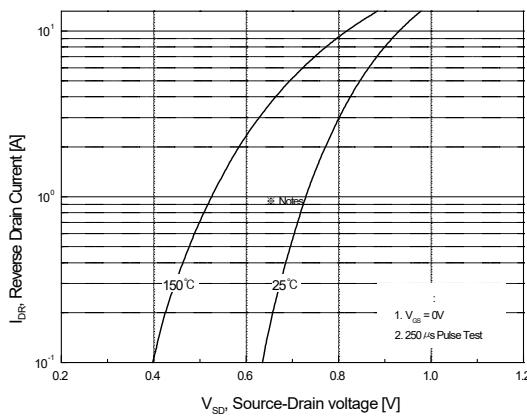


Figure 2. Transfer Characteristics



**Figure 3. On-Resistance Variation vs
Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage
Variation with Source Current
and Temperature**

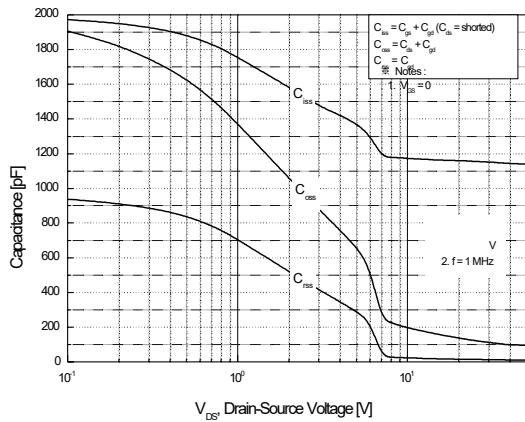


Figure 5. Capacitance Characteristics

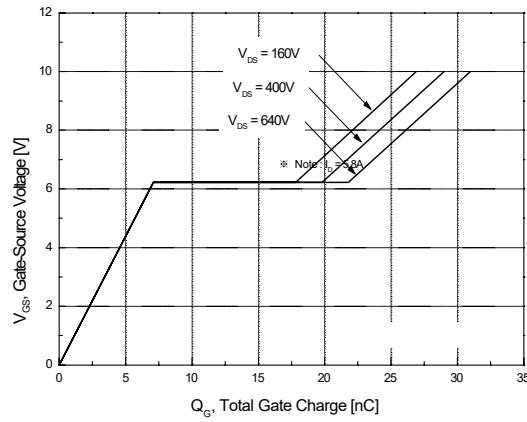


Figure 6. Gate Charge Characteristics

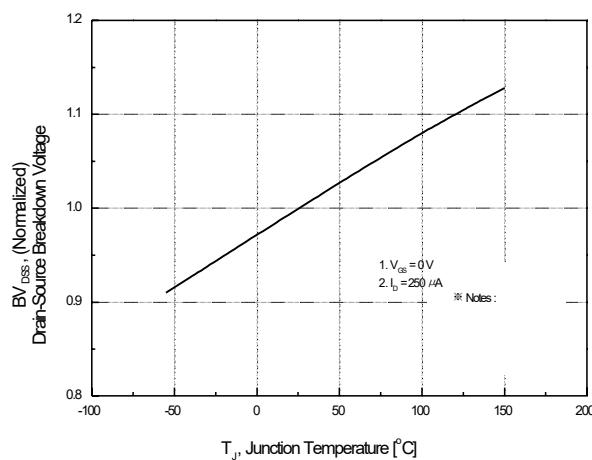


Figure 7. Breakdown Voltage Variation vs Temperature

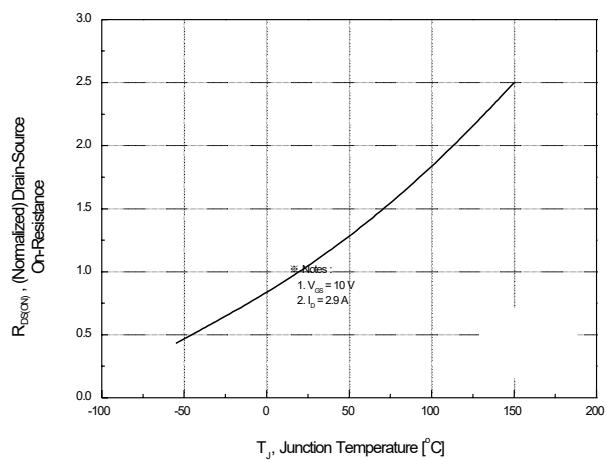


Figure 8. On-Resistance Variation vs Temperature

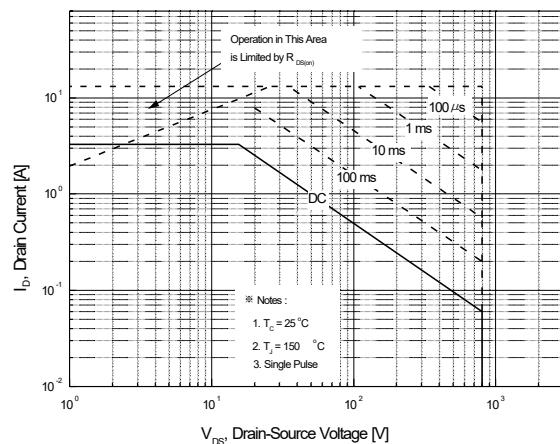


Figure 9. Maximum Safe Operating Area

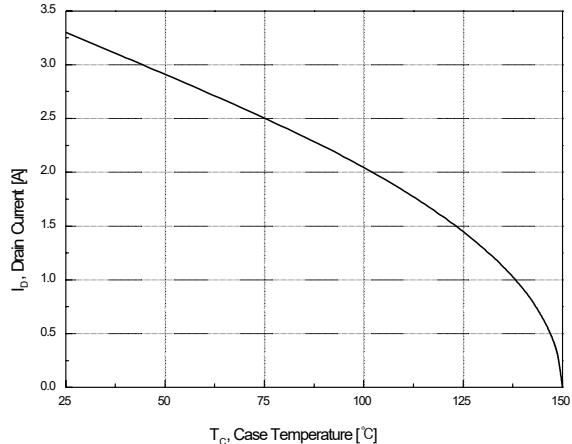


Figure 10. Maximum Drain Current vs Case Temperature

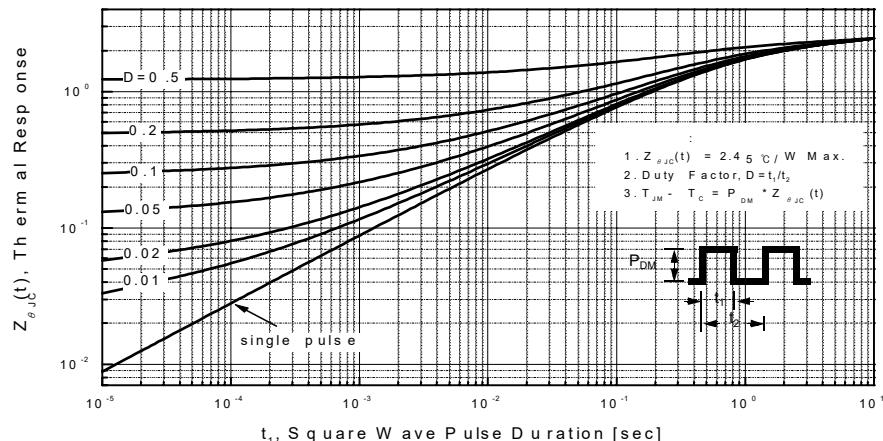
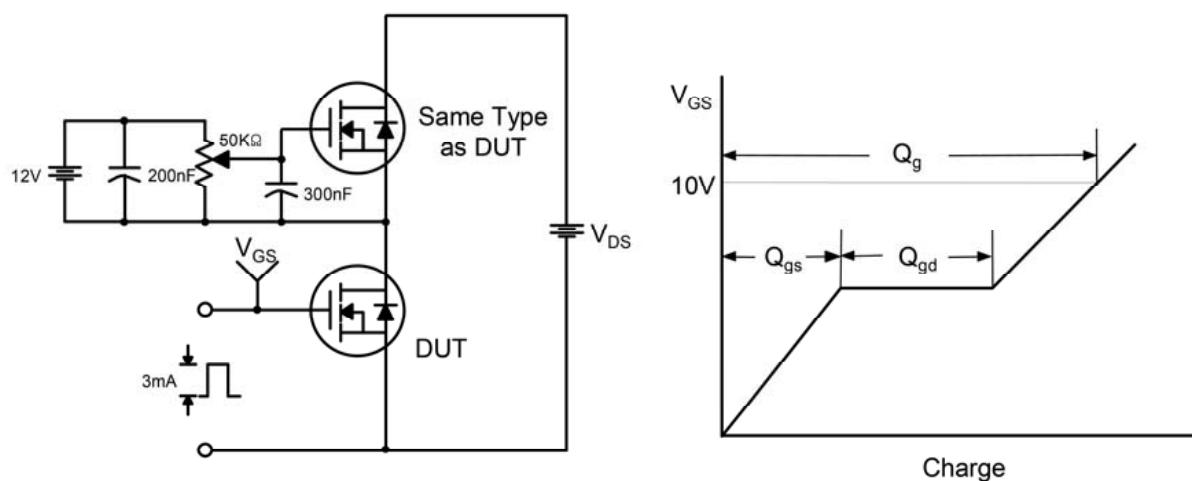
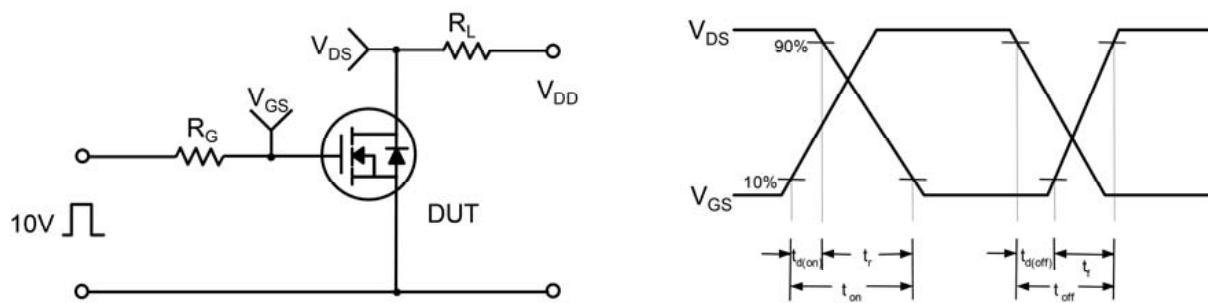


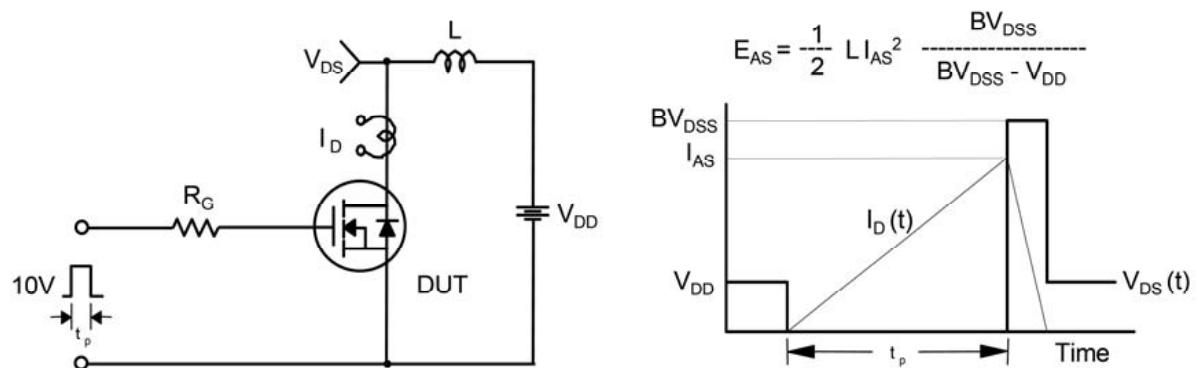
Figure 11. Transient Thermal Response Curve



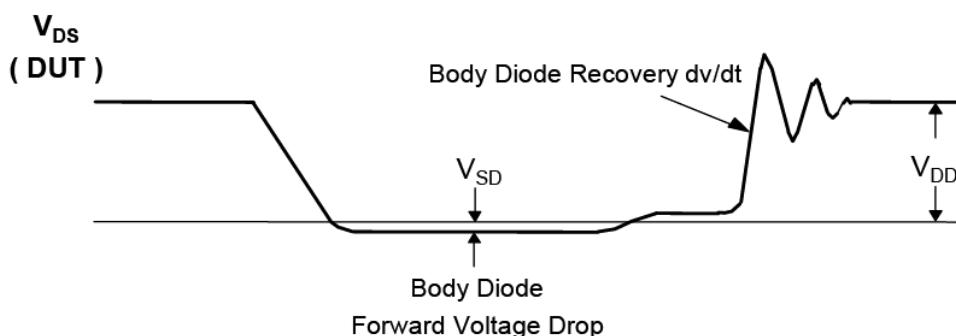
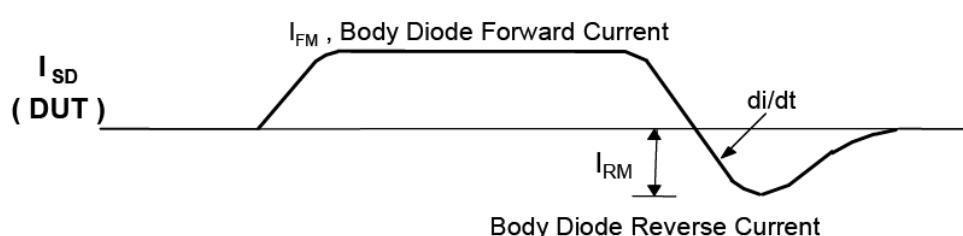
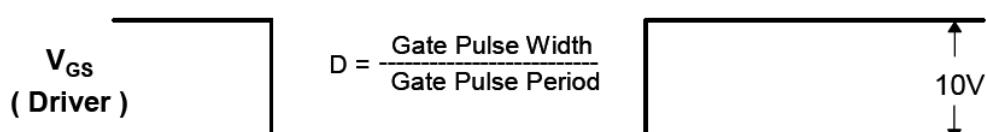
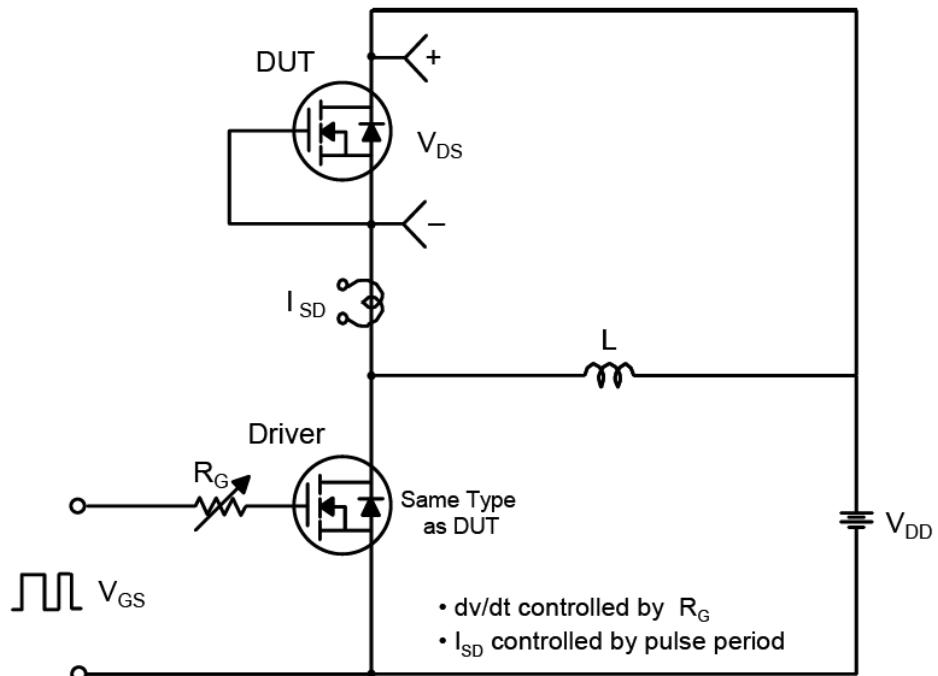
Resistive Switching Test Circuit & Waveforms

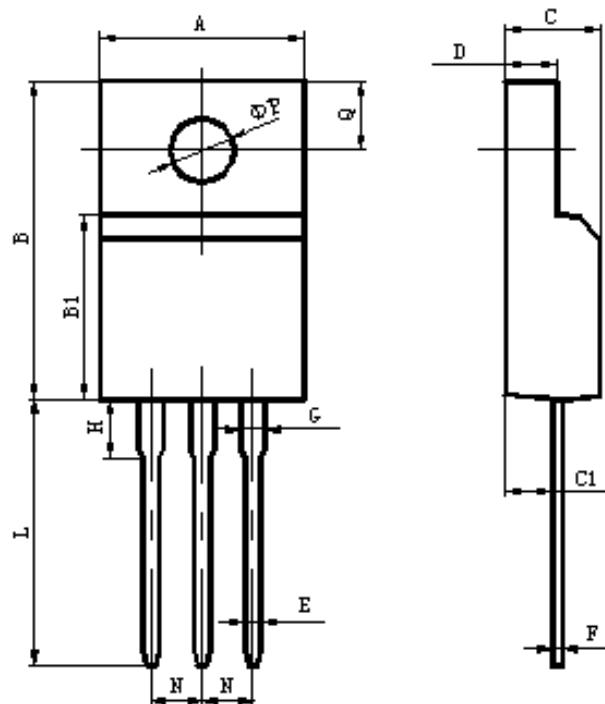


Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveform



Package Mechanical Data-TO-220 Single


Items	Values(mm)	
	MIN	MAX
A	9.60	10.4
B	15.4	16.2
B1	8.90	9.50
C	4.30	4.90
C1	2.10	3.00
D	2.40	3.00
E	0.60	1.00
F	0.30	0.60
G	1.12	1.42
H	3.40	3.80
	2.40	2.90
L*	12.0	14.0
N	2.34	2.74
Q	3.15	3.55
P	2.90	3.30